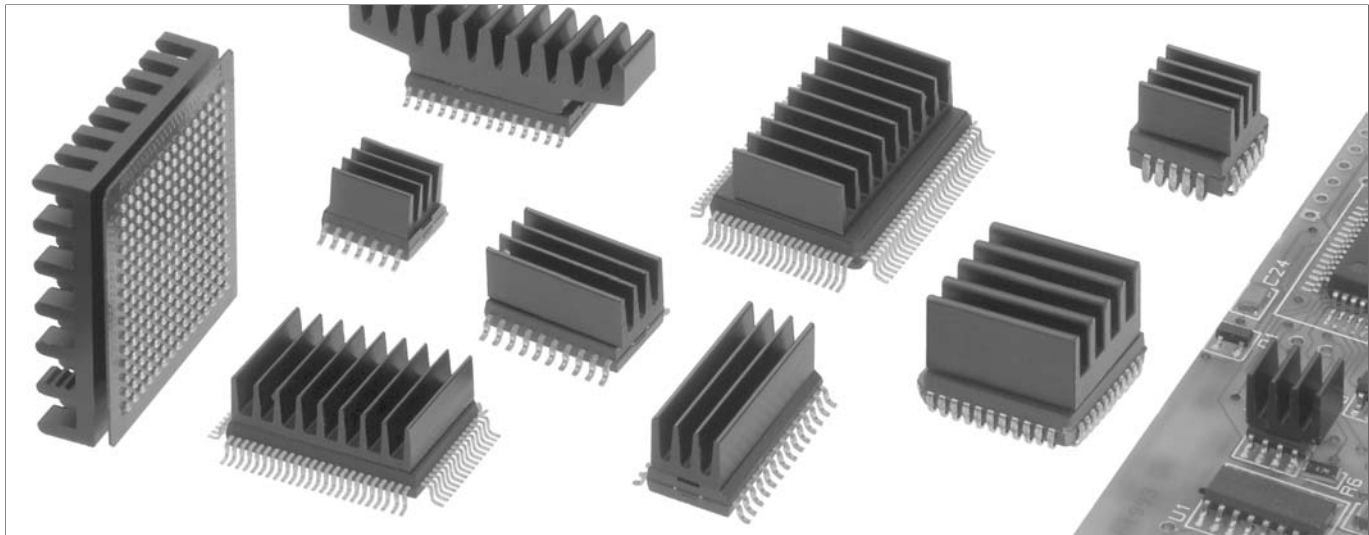
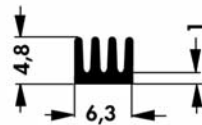


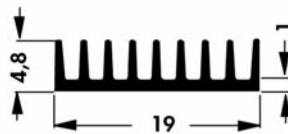
Heatsinks for SMD



- particularly suitable for SMD components
- low profile
- reduced weight
- effective heat dissipation
- can be glued directly onto the component
- soudable versions
- customer specific versions on request
- special packaging like tape and reel, bar magazin, tary etc. on request



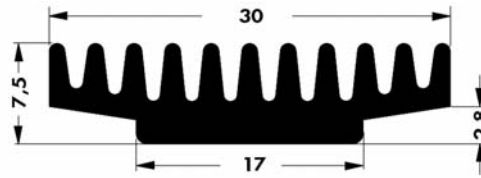
art. no.	↔ [mm]	R_{th} [K/W]
ICK SMD A 5 ...	5	123
ICK SMD A 8 ...	8	87
ICK SMD A 10 ...	10	75
ICK SMD A 13 ...	13	63
ICK SMD A 17 ...	17	51
ICK SMD A 22 ...	22	34



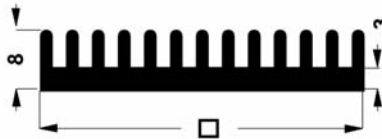
art. no.	↔ [mm]	R_{th} [K/W]
ICK SMD B 5 ...	5	56
ICK SMD B 7 ...	7	47
ICK SMD B 10 ...	10	35
ICK SMD B 13 ...	13	29
ICK SMD B 19 ...	19	22

please indicate:
 ... surface treatment
SA=black anodised
MI=solderable surface

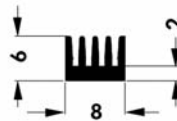
Heatsinks for SMD



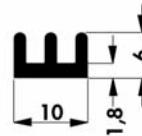
art. no.	↔ [mm]	R _{th} [K/W]
ICK SMD C 7 ...	7	33
ICK SMD C 10 SA	10	26
ICK SMD C 17 ...	17	17



art. no.	↔ [mm]	R _{th} [K/W]
ICK SMD E 15 ...	15.3	27
ICK SMD E 22 ...	22.3	21
ICK SMD E 29 SA	29.0	18



art. no.	↔ [mm]	R _{th} [K/W]
ICK SMD F 8 ...	8	74
ICK SMD F 10 ...	10	71
ICK SMD F 17 SA	17	42
ICK SMD F 19 ...	19	37
ICK SMD F 21 ...	21	33
ICK SMD F 26 ...	26	26



art. no.	↔ [mm]	R _{th} [K/W]
ICK SMD G 8 MI	8	73
ICK SMD G 10 ...	10	70
ICK SMD G 13 SA	13	61
ICK SMD G 17 ...	17	41
ICK SMD G 19 SA	19	36
ICK SMD G 21 ...	21	32

please indicate: ... surface treatment
 SA=black anodised
 MI=solderable surface

Heatsinks for SMD

art. no.	↔ [mm]	R _{th} [K/W]
ICK SMD H 8 ...	8	33.0
ICK SMD H 10 ...	10	29.0
ICK SMD H 17 ...	17	24.5
ICK SMD H 19 SA	19	23.0
ICK SMD H 25 ...	25	20.0
art. no.	↔ [mm]	R _{th} [K/W]
ICK SMD K 8 ...	8	25.6
ICK SMD K 10 SA	10	23.4
ICK SMD K 13 ...	13	21.5
ICK SMD K 17 ...	17	19.4
ICK SMD K 19 ...	19	18.0
ICK SMD K 21 ...	21	16.5
art. no.	↔ [mm]	R _{th} [K/W]
ICK SMD M 8 SA	8	72.0
ICK SMD M 10 ...	10	66.0
ICK SMD M 17 MI	17	40.0
ICK SMD M 19 ...	19	35.0
ICK SMD M 21 SA	21	31.0
ICK SMD M 26 SA	26	30.2
<p>please indicate: ... surface treatment SA=black anodised MI=solderable surface</p>		

Sample box SMD heatsinks

art. no. ICK SMD BOX 1

Contains an assortment of SMD heatsinks with anodised and solderable surface as well as thermally conductive glue (WLK) and double-sided adhesive thermal foil (WLF).

Thermal conduct. foil WLFT 404/405 → E 5
 Thermal conductive glue → E 15
 Thermal conductive paste → E 13
 Silicone wafers → E 2 - 4

Profiles for PCB mounting
 U-shaped heatsink
 Heatsinks for PCB
 Pin heatsinks for IC

→ A 89 - 111
 → A 120 - 122
 → A 89 - 91
 → B 20 - 27

B 40

A

B

C

D

E

F

G

H

I

K

L

M

N